



PRODUCTS CATALOGUE OF OEM ELECTRONICS MARKET

PRODUCTS CATALOG OF OEM ELECTRONICS MARKET



ITW PERFORMANCE POLYMERS & FLUIDS CHEMICAL - GLOBAL

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ABOUT US

2000 A Fortune 200 manufacturing company the United States

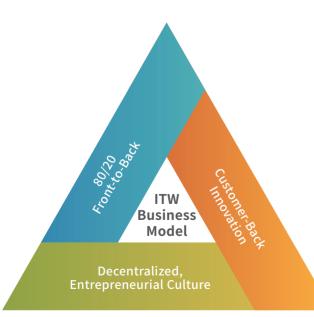
ITW (NYSE:ITW) is a Fortune 200 company in the United States and a leader in global diversification of industrial manufacturing business.



Holder of 17,800 valid patents With its unique business model ,Seven ITW business departments are in the leading position in the industry, assumed the mission to meet customers' needs by constant innovation, helping customers to create new applications to promote the group's steady development.

100 With more than 100 years of history ITW was established in 1912. Headquartered in Chicago, the company has 50,000 employees in 57 countries and regions worldwide.

ITW practices a unique business model featuring decentralized core competencies and encompassing three key elements: 80/20 Front-to-Back, Customer-Back Innovation and Decentralized, Entrepreneurial Culture.



OUR MARKETS

ITW provides professional and(complete) total solutions of adhesives to OEM industries like laptop computers, mobile phones, security, power supplies, power batteries, elevators, LED, RFID, touch screens, etc. and offers an array of products covering methyl methacrylate, epoxy, modified silicane sealants, multi-structural[™] adhesives, polyurethane and UV cured adhesives, etc.

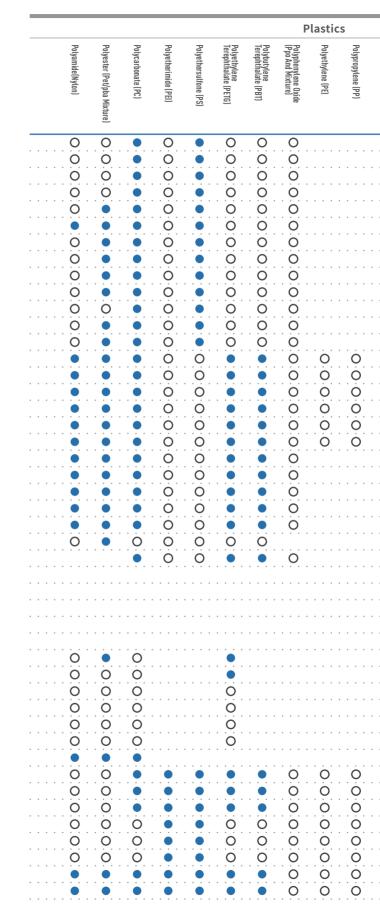
ITW products are for bonding and potting of conventional materials and a variety of materials hard to be bonded. They have protection and heat conductivity actions for potted electronic components. Furthermore, ITW has been bending to product technology innovation, providing professional adhesive application solutions for achieving high-efficiency and high quality, as well as field technical support service by virtue of fast response.

Application Fields of Products



					Met	tals					lastic	S
Chemical Type	Product Name	Aluminum*	Brass	Copper	Electroplating Metal	Stainless Steel*	Cold-rolled Steel*	Galvanized Steel	Zinc	Acrylonitrile-butadiene -styrene Resin (ABS)	Acrylic Resin (PMMA)	rhovà troatti
	Devcon [®] MA2060							0				_
	Devcon [®] Composite Welder™FS											
	Devcon [®] MA216							0				
	Devcon [®] MA209							· · · · · ·				
	Devcon [®] MA2303											
	Devcon [®] MA2315									• • •		
Methyl Methacrylate	Devcon [®] MA2320											
Structural Adhesives	Devcon [®] MA2920					• • •	• • • •					
	Devcon [®] MA2940				· · · · · ·			0				
	Devcon [®] MA2804	• • • • •	• • • •				• • • •			• • • •	• • • •	
	Devcon [®] MA2805	• • • • • •			• • • • •	• • • •	• • • •	• • • •	0	• • • •	• • • •	1
	Devcon [®] MA2807	• • • • • •			• • • • •	• • •	• • • •	• • • •	• • • •	• • • •	• • • •	
	Devcon [®] MA2812	• • • • • •			• • • • •	• • •	• • • •	• • • •		• • • •	• • • •	
	Tru-Bond™ PSA 750	• • • • • • •		•		• • • •	•	•				
	Tru-Bond™ PSA 2500	• • • • • •		•			• • • •	• • • •	•	• • • •	• • • •	
	Tru-Bond™ PSA 4500	• • • • • •		•		•	• • • •	• • • •	•	• • • •	• • • •	
	Tru-Bond™ PSA 11000	• • • • • •		•		•	• • • •	• • • •	• • • •	• • • •	• • • •	
	Tru-Bond™ PSA 21000	• • • • • •		•		•	• • • •	• • • •	•	•	•	
	Tru-Bond™ PSA 30000	• • • • • •		•		•	• • • •	• • • •	•	•	•	
Uv Cured Adhesives	Tru-Bond™ UB 3000	• • • • • •		•		•	• • • •	• • • •		• • • •	• • • •	-
	Tru-Bond™ UB 20000	• • • • • •		•		•	•	•		• • • •	•	
	Tru-Bond™ PB 950									•	•	
	Tru-Bond™ PB 3500									•	•	
	Tru-Bond™ PB Gel									•	•	
	Tru-Bond™ DC 1000	•		0		•	•	0	0	•	•	Ì
	Tru-Bond™ PM Gel			0		0	0	0		•		
	Devcon [®] 5 Minute [®] Epoxy	•	•	•	0	•	•		0	0		(
	Devcon® 5 Minute® Epoxy I- FR	•	•		0	•	•		0	0		
	Devcon® 10 Minute® Epoxy	•			0			•	•	0	0	
	Devcon® 10 Minute® Epoxy I- FR	•			0					0	0	Ì
Epoxy Structural	Devcon [®] 2-Ton [®] Epoxy	•			0							(
Adhesives	Devcon® Epoxy Plus™ 25	•			0			0		0		
	Devcon® HP250	•			0						0	
	Devcon [®] EP6060	•	0	0	•	•	•		0		0	
	Devcon® T- Bond E90	•	0	0			•		0		0	
	Devcon® T- Bond E5	•	0	0		•	•		0		0	
	Devcon® T- Bond E8			. 0					. 0		0	
			•					•				
noacrylates Instant Dry Adhe						•	•			•		
	sives Devcon® CA2400 Devcon® HA1804	•										
noacrylates Instant Dry Adhe Multi-structural TM Adhesives	Devcon® HA1804 Devcon® HA1808	•										
Multi-structural	Devcon® HA1804						•					
TM Adhesives	Devcon® HA1804 Devcon® HA1808 Devcon® HA1820 Devcon® Dev-Thane 2130	•						•	•	•	•	
Multi-structural	Devcon® HA1804 Devcon® HA1808 Devcon® HA1820							•	•	• 0 0	• 0 0	
Multi-structural TM Adhesives Polyurethane	Devcon® HA1804 Devcon® HA1808 Devcon® HA1820 Devcon® Dev-Thane 2130 Devcon® NOVATTANE 2100				•		•		•	• 0 0	• 0 0	-
Multi-structural TM Adhesives Polyurethane	Devcon® HA1804 Devcon® HA1808 Devcon® HA1820 Devcon® Dev-Thane 2130 Devcon® NOVATTANE 2100 Devcon® NOVATTANE 2100S SM1030						•				• 0 0 0	

• Good O General Blank: Not Recommended



* For reference only, bonding properties test results shall prevail for materials in practice.

								Oth	ners	
Polyphenylene Sulfide (PPS)	Polystyrene (PS)	Phenol Formaldehyde Resin	Polyurethane (PUR)	Soft Polyvinyl Chloride (PCV)	Hard Polyvinyl Chloride (PVC)	Styreneacrylonitrile (SAN)	Vitreous	Glass	Ferric oxide	Ceramics
				• Good	d C) Gene	ral	Blank:	Not Recom	ımended

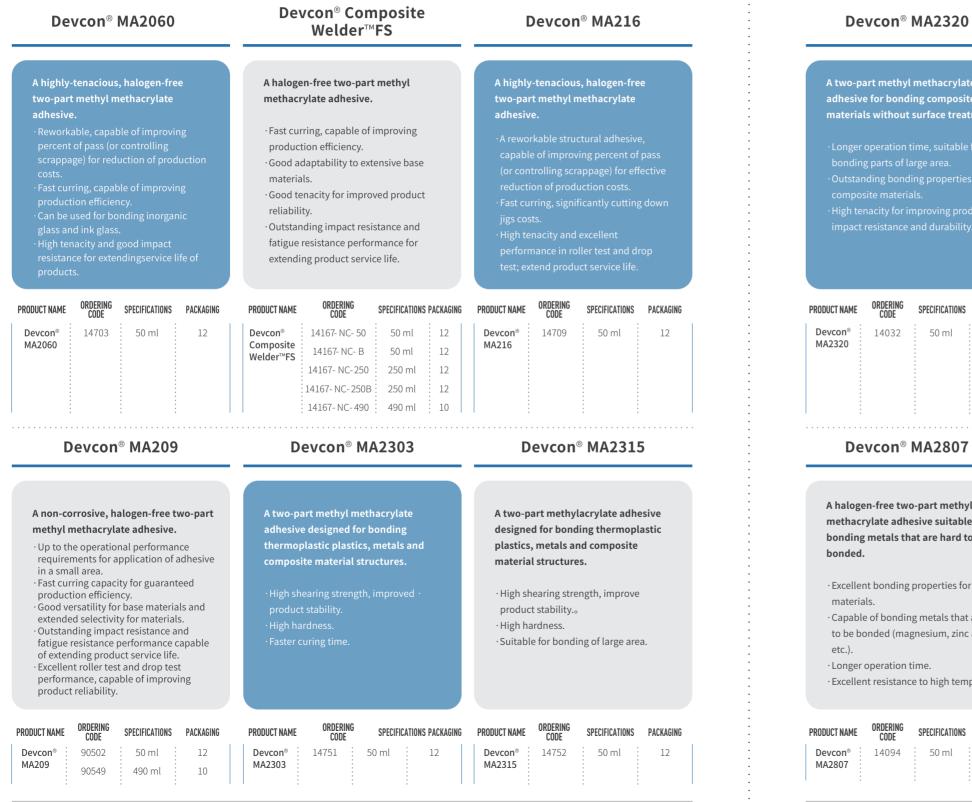
Methyl Methacrylate Structural Adhesives

Devcon®

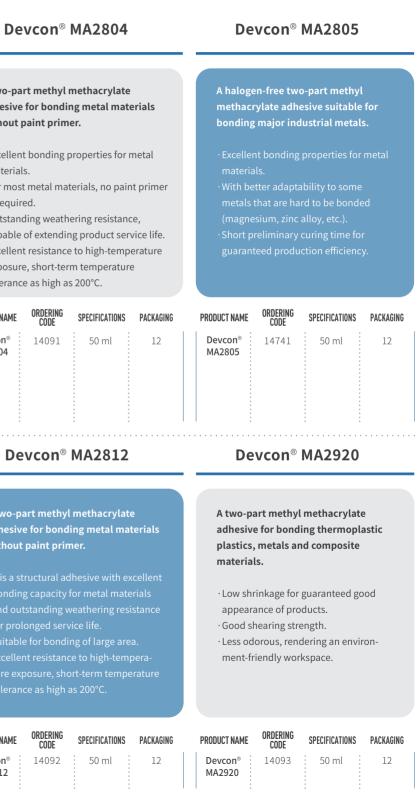
Methyl Methacrylate Structural Adhesives

Product Description

High performance methyl methacrylate structural adhesives that can be used for bonding metals, plastics, composite materials and engineering plastics that are hard to be bonded. Featuring simple operation, fast curing, and high strength. Once cured, product is provided with excellent impact resistance, fatigue resistance, and resistance to high-frequency vibration, etc.



Devcon MA2320	Devcon MA2
vo-part methyl methacrylate esive for bonding composite erials without surface treatment.	A two-part methyl method adhesive for bonding met without paint primer.
nger operation time, suitable for nding parts of large area. tstanding bonding properties for mposite materials. gh tenacity for improving product pact resistance and durability.	 Excellent bonding propert materials. For most metal materials, is required. Outstanding weathering re capable of extending prod Excellent resistance to hig exposure, short-term temp tolerance as high as 200°C
AME ORDERING SPECIFICATIONS PACKAGING	PRODUCT NAME ORDERING SPECIFI
0 14032 50 ml 12 Devcon [®] MA2807	Devcon [®] 14091 50 MA2804 Devcon [®] MA2
logen-free two-part methyl hacrylate adhesive suitable for ding metals that are hard to be ded.	A two-part methyl metha adhesive for bonding me without paint primer.
cellent bonding properties for metal terials. pable of bonding metals that are hard be bonded (magnesium, zinc alloy, .). nger operation time. cellent resistance to high temperature.	 It is a structural adhesive bonding capacity for met and outstanding weather for prolonged service life Suitable for bonding of la Excellent resistance to hig ture exposure, short-term tolerance as high as 200°
AME ORDERING SPECIFICATIONS PACKAGING 1° 14094 50 ml 12 7	PRODUCT NAME ORDERING CODE SPECIFI Devcon® 14092 50 MA2812



Methyl Methacrylate Structural Adhesives

Devcon®

Methyl Methacrylate Structural Adhesives

Devcon[®] Product Series' Technical Parameters

Product Name	Color	Mixing Ratio	Viscosity (Cps)	Operation Time (Min)	Clamping Duration (Min)	Specific Gravity	Tensile Shearing Strength (Mpa)	Rate of Elongation (%)	Temperature Tolerance Range(°c)
Devcon [®] MA2060	Baby blue	10:1	A: 15,000~35,000 B: 15,000~35,000	3~4	4~7	1.03	10.0~12.0	100~120	- 40~121
Devcon® Composite P @ R Welder™FS	Blue/black	10:1	A: 100,000∼130,000 B: 15,000∼35,000	3~5	7~9	1.05	17.1	20~50	- 40~121
Devcon® MA216 🕂 🔁 R	Baby blue	10:1	A: 16,000∼36,000 B: 15,000∼35,000	3.5~5	4~8	1.03	10.0~11.5	100~120	- 40~121
Devcon® MA209	Baby blue	10:1	A: 105,000∼131,000 B: 15,000∼35,000	3.5~5.5	7~10	1.05	16.8	20~50	- 40~121
Devcon® MA2303 RB R	White paste and black	1:1	A: 40,000~70,000 B: 40,000~70,000	3~6	12~15	0.97	20.7~27.6	5~15	- 55~121
Devcon [®] MA2315 RB	Creamy white /straw color	1:1	A: 40,000~70,000 B: 40,000~70,000	15~18	45~55	1.00	20.7~24.1	5~15	- 55~121
Devcon® MA2320	Creamy white /straw color	10:1	A: 40,000~70,000 B: 40,000~70,000	8~12	25~30	0.93	10.3~13.8	100~140	- 55~121
Devcon® MA2804	Creamy white /gray	10:1	A: 80,000∼120,000 B: 35,000∼80,000	4~6	15~25	0.99	13.8~19.3	30~60	- 40~82
Devcon® MA2805 H 🔁 R	Baby blue	10:1	A: 15,000~50,000 B: 40,000~70,000	3~4	7~9	0.95	14.3~15.8	10~40	- 40~121
Devcon® MA2807	Creamy white /straw color	1:1	A: 25,000∼50,000 B: 40,000∼60,000	7~9	32~36	0.95	15.5~16.8	10~30	-40~121
Devcon® MA2812	Skin color/gray	10:1	A: 80,000∼130,000 B: 35,000∼80,000	12~16	55~60	1.00	13.8~19.3	30~60	-40~82
Devcon® MA2920	Blue	10:1	A: 100,000∼125,000 B: 40,000∼70,000	4~6	15~20	0.99	8.6~11.0	90~110	- 40~82
Devcon® MA2940	Creamy white /straw color	10:1	A: 135,000∼175,000 B: 35,000∼70,000	12~15	25~30	0.98	8.3~13.8	125~175	- 40~121

Devcon [®] MA2940	PC120 Paint Primer	PC150 Paint Primer				
A two-part methyl methacrylate adhesive designed for bonding thermoplastic plastics.	A chemical paint primer. • Capable of improving bonding results and durability of metals.	A chemical paint primer. • With improved bonding properties for EPDM, PA, ABS, AES, PP, chloroprene				
 Outstanding structural bonding properties. Outstanding impact resistance, tenacity and fatigue resistance for improved product reliability. Long operation time for meeting the 	• Dried quickly at room temperature, allowing for normal application of adhesive within 1 minute.	rubber and PET/PBT composite materials. • Dried fast at room temperature.				
requirements of a variety of processes.	ODDEDING	ODEDING				
PRODUCT NAME ORDERING CODE SPECIFICATIONS PACKAGING Devcon® 14031 50 ml 12 MA2940 12 12 12	PRODUCT NAME ORDERING CODE Specifications Packaging PC120 ID120 1 QUART 1	PRODUCT NAME ORDERING CODE SPECIFICATIONS PACKAGING PC150 ID150 250ml 1 PC150 Red ID150R 250ml 1				





09

UV Cured Adhesive

Product Description

High performance methyl methacrylate structural adhesives that can be used for bonding metals, plastics, composite materials and engineering plastics that are hard to be bonded. Featuring simple operation, fast curing, and high strength. Once cured, product is provided with excellent impact resistance, fatigue resistance, and resistance to high-frequency vibration, etc.

PRODUCT NAME

Tru-Bond[™] PSA 750

Tru- Bond[™] Pressure-sensitive Adhesives (PSA series)

		18474	1L	1
	Tru-Bond™ PSA 2500	18471	30 ml	12
One-part environment-friendly UV		18475	1L	1
adhesives which, upon exposure to	Tru-Bond™ PSA 4500	18450	1L	1
light, are cured to form a high	The Boline PSA 4500	18429	18 KG	1
performance pressure-sensitive		18453	30 ml	12
adhesive that has high initial viscosity		18745	30 ml	12
and high bonding strength for		18452 18480	30 ml 30 ml	12 12
bonding a variety of plastics, metals				12
and PP that is hard to be bonded.	Tru-Bond™ PSA 11000	18453	30 ml	12
and fr that is hard to be bonded.		: 18450 : 18429	1 L 18 kg	
Lligh performance processo consitive		18452*	: 30 ml	12
· High performance pressure-sensitive			*	
adhesives that can be used in place of	Tru-Bond™ PSA 21000	18424	30 ml	12
die-cut tapes. Bonding with fast speed.		18423* 18426*	30 ml 30 ml	12 12
· Flexible adhesive application process.		. 10120	- JUIIII	. 12
• Outstanding surface adaptability.	Tru-Bond [™] PSA 30000	18436	30 ml	12
		: 18400* : 18435*	: 30 ml : 30 ml	12 12
		. 10435	. 50 m	. 12
Tru-Bond™ niversal Bonding Light Curing	Tru-Bond™ Plastic Bondin	g	Tru- Bo Double Curi	
				ng Coating
niversal Bonding Light Curing	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV ligh light curing adhesives widely bonding plastics.	ies) t/visible	Double Curi (DC se Cured by UV/VIS ligh providing a double- protective coating.	ng Coating ries) t or heating for cured potting
Adhesive (UB series) Auniversal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics.	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV light light curing adhesives widely bonding plastics.	ies) t/visible	Cured by UV/VIS ligh providing a double-oprotective coating.	ng Coating ries) t or heating for cured potting
A universal Bonding Light Curing Adhesive (UB series)	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV ligh light curing adhesives widely bonding plastics. • For bonding most plastics. • Excellent elasticity.	ies) t/visible used for	Double Curi (DC se Cured by UV/VIS ligh providing a double- protective coating. • UV/VIS light/heat curi • Clear, scratch-proof	ng Coating ries) t or heating for cured potting
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding.	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV light light curing adhesives widely bonding plastics.	ies) t/visible used for	Double Curi (DC se Cured by UV/VIS ligh providing a double-oprotective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage.	ng Coating ries) t or heating for cured potting ring processes. protective layer.
A universal Bonding Light Curing Adhesive (UB series) A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV ligh light curing adhesives widely bonding plastics. • For bonding most plastics. • Excellent elasticity.	ies) t/visible used for	Double Curi (DC se Cured by UV/VIS ligh providing a double- protective coating. • UV/VIS light/heat curi • Clear, scratch-proof	ng Coating ries) t or heating for cured potting ring processes. protective layer.
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact resistance.	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV ligh light curing adhesives widely bonding plastics. • For bonding most plastics. • Excellent elasticity.	ies) t/visible used for	Double Curi (DC se Cured by UV/VIS ligh providing a double-oprotective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage.	ng Coating ries) t or heating for cured potting ring processes. protective layer.
A universal Bonding Light Curing Adhesive (UB series) A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV ligh light curing adhesives widely bonding plastics. • For bonding most plastics. • Excellent elasticity.	ies) t/visible used for	Double Curi (DC se Cured by UV/VIS ligh providing a double-oprotective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage.	ng Coating ries) t or heating for cured potting ring processes. protective layer.
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact resistance.	Plastic Bondin Adhesive (PB ser	ies) t/visible used for	Double Curi (DC se Cured by UV/VIS ligh providing a double-oprotective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage.	ng Coating ries) t or heating for cured potting ring processes. protective layer.
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact resistance. • Good weathering resistance. • PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING CODE SPECIFICATIONS PACKAGING	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV light light curing adhesives widely to bonding plastics. • For bonding most plastics. • For bonding most plastics. • Excellent elasticity. • Outstanding impact resistance. PRODUCT NAME ORDERING CODE SPECIFICATI 1 Tru-Bond™ 18204 1	t/visible used for ONS PACKAGING PI	Double Curi (DC set Cured by UV/VIS ligh providing a double- protective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage. • Anti-scratching coati RODUCT NAME ORDERING CODE ru-Bond™ 18301	ng Coating ries) t or heating for cured potting ring processes. protective layer. ng.
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact resistance. • Good weathering resistance.	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV light light curing adhesives widely to bonding plastics. • For bonding most plastics. • For bonding most plastics. • Excellent elasticity. • Outstanding impact resistance.	t/visible used for ONS PACKAGING PI	Cured by UV/VIS ligh providing a double- protective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage. • Anti-scratching coati	ng Coating ries) t or heating for cured potting ring processes. protective layer. ng.
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact resistance. • Good weathering resistance. PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING CODE SPECIFICATIONS PACKAGING Tru-Bond [™] 18705 30 ml 12 JB 3000 1 L 1	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV light light curing adhesives widely to bonding plastics. • For bonding most plastics. • For bonding most plastics. • Excellent elasticity. • Outstanding impact resistance. PRODUCT NAME ORDERING CODE SPECIFICATI Tru-Bond™ 18204 1 L PB 950 10005 20 ml	t/visible used for ONS PACKAGING PI	Double Curi (DC set Cured by UV/VIS ligh providing a double- protective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage. • Anti-scratching coati RODUCT NAME ORDERING CODE ru-Bond™ 18301	ng Coating ries) t or heating for cured potting ring processes. protective layer. ng.
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact resistance. • Good weathering resistance. • RODUCT NAME ORDERING SPECIFICATIONS PACKAGING Tru-Bond [™] 18705 30 ml 12 18706 1 L 1 Tru-Bond [™] 18725 30 ml 12	Plastic Bondin Adhesive (PB seriors) One-part, solvent-free UV light light curing adhesives widely to bonding plastics. • For bonding most plastics. • For bonding most plastics. • Excellent elasticity. • Outstanding impact resistance. PRODUCT NAME ORDERING CODE SPECIFICATION Tru-Bond™ 18204 1 L	t/visible used for ONS PACKAGING PI	Double Curi (DC set Cured by UV/VIS ligh providing a double- protective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage. • Anti-scratching coati RODUCT NAME ORDERING CODE ru-Bond™ 18301	ng Coating ries) t or heating for cured potting ring processes. protective layer. ng.
A universal bonding UV light/visible light curing adhesive that can be used for bonding glass, gold, ceramics and plastics. • For bonding rigid and flexible materials. • Providing robust, high strength bonding. • Outstanding elasticity and impact resistance. • Good weathering resistance. PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING CODE SPECIFICATIONS PACKAGING Tru-Bond [™] 18705 30 ml 12 JB 3000 1 L 1	Plastic Bondin Adhesive (PB ser One-part, solvent-free UV light light curing adhesives widely to bonding plastics. • For bonding most plastics. • For bonding most plastics. • Excellent elasticity. • Outstanding impact resistance. PRODUCT NAME ORDERING CODE SPECIFICATI 1 L Tru-Bond™ 18204 1 L Tru-Bond™ 18205 30 ml	t/visible used for ONS PACKAGING PI	Double Curi (DC set Cured by UV/VIS ligh providing a double- protective coating. • UV/VIS light/heat cur • Clear, scratch-proof • Low shrinkage. • Anti-scratching coati RODUCT NAME ORDERING CODE ru-Bond™ :: 18301	ng Coating ries) t or heating for cured potting ring processes. protective layer. ng.

* These products are available in China only	available in China only
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UV Cured Adhesive

Special I	Tru-Bo Purpos (SP ser	Tı Liquid Adhesive			
light curing bonding pl	g adhesives astics. Fbonding m lasticity.	e UV light/vi s widely use nost plastics. esistance.		Highly-clear adhesives. • For eliminati protection gl and backlit m equipment. • Readily level • Helpful to rea Mura. Also he impact resist	ng gaps be ass, touch nodule of e ed, ultra-le duce stress
PRODUCT NAME	ORDERING CODE	SPECIFICATIONS	PACKAGING	PRODUCT NAME	ORDERING Code
PM Gel	18970	250 ml	1	Tru-Bond [™] PSA LOCA 3000 Tru-Bond [™] PSA LOCA 3000 Tru-Bond [™] LOCA 2800 Tru-Bond [™] LOCA 2800	18184 18187 18195 18198
* These products		ble in China			

Devcon®

PACKAGING

12

SPECIFICATIONS

30 ml

ORDERING CODE

18470

Bond™ tical Clear LOCA series)

light fast curing

s between the uch control module of display

a-low hardness. ress caused by o improving overall nd durability.

NG SPECIFICATIONS PACKAGING

	JFEGIFICATIONS	FACKADINO
:	2 Kg	6
:	10.1/	
:	18 Kg	1
	2 Kg	6
	10.14	
:	18 Kg	1



UV Cured Adhesive

Technical Parameters

An adhesive layer thickness of 2mil (0.05mm) that bonds aluminum film to stainless steel sheet. 1500 mJ/cm² exposure

Product Category	Product Name	Color	Viscosity (Cps)	Specific Gravity	Temperature Tolerance Range(°c)	90° peel adhesive test at room temperature for 15 minutes N/25mm	90°peel adhesive test at room temperature for 72 minutes N/25mm	90°peel adhesive test at 158°F (70°C) for 72 hours N/25mm	180°peel adhesive test at room temperature for 72 hours N/25mm	90°peel adhesive test for 7 days N/25mm
· · · · · · · · · · · · · · · · · · ·	Tru- Bond™ PSA 750 H № R	Clear	750	1.04	- 40~93	22.7	17.8	37.8	23.1	24.5
	Tru- Bond™ PSA 2500 ℍ 限 ℝ	Clear	2,500	1.03	- 40~93	24.9	32	35.6	46.3	43.1
Tru- Bond™ Pressure -sensitive	Tru- Bond™ PSA 4500 ℍ ᄜ R	Clear	4,500	1.07	- 40~121	22.7	25.8	33.8	36	36.9
Adhesives (PSA series)	Tru- Bond™ PSA 11000 ℍ 限 ℝ	Clear	11,000	1.1	- 40~121	19.1	16.5	38.3	48	47.2
• • • • • • • • • • • • • • • • • • •	Tru- Bond™ PSA 21000 H ॡ R	Clear	21,000	1.1	- 40~121	18.7	35.6	55.2	45.8	53.4
· · · · · · · · · · · · · · · · · · ·	Tru- Bond™ PSA 30000 ⊕ ? ®	Clear	30,000	1.12	- 40~121	11.8	10.2	29.4	21.4	18.2

Product Category	Product Name	Color	Viscosity (Cps)	Specific Gravity	Tensile Strength (Psi)	Rate Of Elongation (%)	Volumetric Shrinkage Rate(%)	Hardness (Shore)	Temperature Tolerance Range(°c)
Tru- Bond™ Universal Bonding	Tru- Bond™ UB 3000 (+)	Clear	3,000	1.07	312	214	5.8	90A	- 54~149
Light Curing Adhesives (UB series)	Tru- Bond™ UB 20000 ℍ መ ℝ	Clear	20,000	1.00	718	203	7.27	91A	- 54~149
Tru- Bond™ Plastic Bonding Adhesives	Tru- Bond™ PB 950 ℍ ᄜ ℝ	Clear	950	1.00	511	348	7.41	42D	- 54~149
	Tru- Bond™ PB 3500 ℍ ഢ ℝ	Clear	3,500	1.00	480	325	9.00	50D	- 54~149
(PB series)	Tru- Bond™ PB Gel ⊣ ॡ ℝ	Amber	Gel	1.03	577	359	8.74	37D	- 54~149
Tru- Bond™ Double Curing Coating (DC series)	Tru- Bond™ DC 1000 ℍ መ ℝ	Clear	1,000	1.17	1028	7.4	5.65	78D	- 54~149
Tru- Bond™ Special Purpose Adhesives (SP series)	Tru- Bond™ PM Gel ℍ ᄜ ℝ	Amber	Gel	1.28	735	178	1.32	66A	- 54~121
Tru-Bond™ Liquid Optical	Tru- Bond™ LOCA 2800 ℍ ඖ ℝ	Clear	3,000	1.07	312	214	5.8	90A	- 54~149
Clear Adhesives (LOCA series)	Tru-Bond™ PSA LOCA3000 IH) RH R	Clear	20,000	1.00	718	203	7.27	91A	- 54~149

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Epoxy Adhesives

Devcon®

Product Description

High performance epoxy structural adhesives which are widely used for bonding, potting, and/or repairing products and for providing diversified operation time and packaging specifications to meet customers' diversified application requirements.

5 Min	ute® E	роху		10 Mi	nute [®] Epo	K'
Fast curring, gr structural adh operation time used for bondi timber. • Solvent-free ar therefore more • Good solvent r product corros • Halogen-free o Epoxy I-FR). • Up to the requ retardant certi with UL94.V- 0 I- FR).	esives wh e of 3-6 m ng metals nd comple e environr esistance sion resist ertified (f irements fication ir	ich, having inutes, can s and/or etely reacted ment-friend for better ance. or E Minute' for flame a accordanc	be d, ly. e	impact resist: strength and resistance. Good impact product relia Self-leveling High shearin product stab Up to the req V-0(suitable f flame retarda	for convenient ope g strength, improv	g oro er (4,)(4,
PRODUCT NAME	ORDERING	SPECIFICATIONS	PACKAGING	PRODUCT NAME	ORDERING CODE SPECIFICAT	101
Devcon [®] 5 Minute [®] Epoxy	CODE	50 ml	12	Devcon [®] 10 Minute Epoxy	OODE	l
Devcon [®] 5 Minute [®]	14272	50 ml	12	Devcon [®] 10 Minute Epoxy	[®] 14255 50 ml	l
Epoxy I- FR	14273	200 ml	12	Devcon [®] 10 Minute Epoxy I-FR	® 14258 50 m	l
Ероху	Plus	™ 25		Devc	on [®] HP250	

 Modified and intensified epoxy structural adhesives that have good anti-peeling performance, shock resistance and fatigue resistance. Shrinkage-free for improving product yield. High insulation property for better safety. Outstanding durability and flexibility for improved product reliability. 	A two-part methyl methacrylate adhesive for bonding metal materials without paint primer. • A structural adhesive with excellent bonding capacity for metal materials. • Outstanding weathering resistance for prolonged service life. • Suitable for bonding of large area. • Excellent resistance to high-tempera- ture exposure, short-term temperature tolerance as high as 200°C.	 High performance, intensified structural epoxy adhesives that have outstanding impact resistance and weathering resistance and can be used for bonding metals, composite materials, stainless steel, nylon, etc. High strength for improving product stability. Outstanding chemical resistance and salt mist resistance that improve product reliability and service life. Up to halogen-free environ- ment-friendly requirements.
PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING	PRODUCT NAME ORDERING CODE SPECIFICATIONS PACKAGING	PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING
Devcon® Epoxy 14278 50 ml 12 Plus™ 25	Devcon® HP250 14315 50 ml 12 14415 400 ml 12	Devcon® 14080 400 ml 12 EP6060 14081 50 ml 12
	: : : : :	

11

e [®] Epoxy	2-Ton [®] Epoxy						
esive with high igh peeling hemical media	High-strength, waterproof, self-level- ing clear epoxy adhesives.						
nce for improved venient operation. gth, improved	 Shrinkage-free curing for improving product yield. Curing at room temperature for production process simplification. Good impact resistance for extended 						
nts for UL94, linute® Epoxy I-FR) ng certification. ed (for 10 Minute®	service life of products. • For high strength bonding of metals, ceramics, timbers, concrete, glass, etc. • Halogen-free certified.						
INC	DEDDUCT NAME ORDERING OFFICIATIONS DASKAGING						
ING SPECIFICATIONS PACKAGING	CODE SPECIFICATIONS PACKAGING						
51 50 ml 12	Devcon® 2-Ton® 14260 50 ml 12 Epoxy						

1	50 ml	-	12
5	50 ml		12
8	50 ml	• • • • •	12

5	50 ml	- - - - - - - - -	12
8	50 ml	* * * *	12

Devcon[®] EP6060

Epoxy Adhesives

Devcon®

Epoxy Adhesives

Technical Parameters

Product Name	Color	Mixing Ratio	Viscosity After Mixing(Cps)	Operation Time (Min)	Clamping Duration (Min)	Specific Gravity	Hardness	Elongation (%)	Tensile Shearing Strength (Mpa)	lmpact Strength (Kj/m²)	Temperature Tolerance Ange(°c)
Devcon® 5 Minute ® Epoxy	Clear	1:1	10,000	3~6	10~15	1.10	85D	1	13.1	11.6	- 40~93
Devcon® 5 Minute ® Epoxy I- FR 🔒 健 R	White	1:1	55,000	4~6	10~15	1.25	84D	1	10.8	11.6	- 40~93
Devcon® 10 Minute® Epoxy	Clear	1:1	80,000	10	20~25	1.13	75D	5	16.6	21.0	- 55~93
Devcon® 10 Minute® Epoxy ₨	Black	1:1	90,000	10	20~25	1.13	75D	5	16.6	21.0	- 55~93
Devcon® 10 Minute ® Epoxy I- FR 🕄 😳 R	White	1:1	90,000	10	20~25	1.13	75D	5	16.6	21.0	- 55~93
Devcon [®] 2-Ton [®] Epoxy ₨	Clear	1:1	8,000	8~12	30~35	1.10	83D	1	15.5	11.6	- 40~93
Devcon® Epoxy Plus™ 25 ඎ	Gray	1:1	70,000	25	210	1.20	74D	20	19.0	21.0	- 40~93
Devcon [®] HP250 RH	Light yellow /gray	2:1	105,000	65	360	1.08	78D	25	22.1	25.2	- 55~121
Devcon [®] EP6060 H 🛯 R	Green	2:1	10,000~ 20,000	60	480	1.07	75D	25	22.7	29.1	- 55~121

Product Name	Color	Mixing Ratio	Density After Mixing (G/cm³)	Viscosity After Mixing (Cps)	Operation Time (Min)	Clamping Duration (Min)	Coefficient Of Thermal Expansion (/°c)	Hardness (Shore)	Coefficient Of Thermal Conductivity (W/m-k)		Compliant With Applicable Flame Retardant Requirements
Devcon [®] T- Bond E5	Black	1:1	1.95	45,000~65,000	3~5	10~15	107×10 ⁻⁶	65D	0.90	- 40~93	UL94,V- 0
Devcon® T- Bond E8 🔃 R	Black	1:1	1.93	70,000~90,000	3~5	18~20	110×10 ⁻⁶	70D	1.0	- 40~85	UL94,V- 0
Devcon [®] T- Bond E90 🔃 R	Black	1:1	1.89	40,000~60,000	15~20	40~60	104×10 ⁻⁶	70D	0.90	- 40~105	UL94,V- 0

Devo	con [®] T-Bond E5	Devcon	[®] T-Bond E8	Devco	n® T-Bond E90	
A two-part fast curing	epoxy resin adhesive with speed.	A two-part epox fast curing spee	y resin adhesive with d.	A two-part e medium curi	poxy resin adhesive with ng speed.	
 High coeffi and high s Can be use (aluminun film , PI fili Compliant 	ing strength icient of heat conductivity afety level. ed for bonding most metals n, stainless steel), plastics(PET m , PC) and ceramics. e: with the flame retardant nts in UL94, V-0.	product reliabili · High thermal co product service · Can be used for (aluminum, stain film , PI film , PC	nductivity for prolonged life. bonding most metals nless steel), plastics(PET) and ceramics. the flame retardant	 High bonding strength. High coefficient of thermal conductivity for prolonged product service life. Can be used for bonding most metals (aluminum, stainless steel), plastics (PET film, PI film, PC) and ceramics. Compliant with the flame retardant requirements in UL94, V-0. 		
RODUCT NAME	ORDERING SPECIFICATIONS PACKAGING	PRODUCT NAME ORDER		PRODUCT NAME	ORDERING CODE SPECIFICATIONS PACKAG	
- - - - - - - - - - - - - 	14069R 30.30 Kg 1 (Base Agent) 14069H 26.85 Kg 1 Curing Agent)	Devcon® 140 T-Bond E8 (Base A 1408	X8R 29.7 Kg 1 gent)	Devcon® T-Bond E90	14064 400 ml 12 14068R 27.60 Kg 1 Base Agent) 14068H 29.25 Kg 1	





Cyanoacrylates Instant Dry Adhesives

Product Description

Devcon[®] CA2400



PRODUCT NAME	ORDERING CODE	SPECIFICATIONS	PACKAGING	
	24005	20 g	12	
CA2400	200111	1000 g	1	

Technical Parameters

Product Name	Color	Viscosity (Cps)	Specific Gravity	Tensile Shearing Strength (Mpa)	Joint Filling	Temperature Tolerance — Range(°c)	Curing Speed Steel / plastic / rubber
Devcon [®] CA 2400	Clear	80-120	1.05	20-25	0.05-0.1mm	-50-80	40-70 / 25-50 / 25-50

New generation ITW Devcon[®] instant dry adhe-

sives allow for powerful bonding of multiple different materials within a short time. Their one-part formula facilitate operation and can

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effectively improve labor productivity.



Multi-structural Adhesives (Hybrid)

Product Description

Devcon®

High performance two-part multi-structural[™] adhesives that can be used for bonding metals, plastics, ceramics, glass, composite materials and engineering plastics that are hard to be bonded. Featuring simple operation, fast curing, and wide application coverage of base materials. Once the adhesive is cured, product is provided with high tenacity, impact resistance, and good resistance to aging.

Devcon [®] HA1804	Devcon [®] HA1808	Devcon [®] HA1820
A two-part hybrid adhesive that requires no paint primer. With good bonding properties for regular metals, engineering materials, thermoplastic materials, glass, etc. • These adhesives have a wide application coverage of base materials and can bond most materials. • With moderate elastic modulus and outstanding flexibility. • Outstanding heat resistance, capable of maintaining a strength of 1MPa at 180°C. • Low rate of shrinkage for improving appearance quality.	A two-part multi-structural [™] adhesive that requires no paint primer. With good bonding properties for regular metals, engineering materials, thermoplastic materials, glass, etc. High thixotropic property. High thixotrop	A two-part multi-structural [™] adhesive that requires no paint primer. With good bonding properties not only for regular metals, engineering materials, thermoplastic materials, glass, etc., but also for PET, PA, PP and other materials that are hard to be bonded. • Long operation time. • These adhesives have a wide applica- tion coverage of base materials and can bond most materials. • Outstanding flexibility. • Good bonding strength. • Low rate of shrinkage for improved appearance quality.
PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING	PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING	PRODUCT NAME ORDERING SPECIFICATIONS PACKAGING
HA1804 14032 50 ml 12	HA1808 14400 400 ml 12	HA1820 14401 400 ml 12
	HA1808Adhesive 14900 5 Gal 1	HA1820Adhesive 14902 5 Gal 1
	HA1808 Activator 14901 5 Gal 1	HA1820 Activator 14903 5 Gal 1

Technical Parameters

Product Name	Color	Specific Gravity	Operation Time (min)	Clamping Duration (min)	Tensile Shearing Strength (MPa)	Rate of Elongation (%)	Peeling Strength N/cm	Temperature Tolerance Range (°C)
Devcon® HA1804 🕒 😢 🛛	Black	1.08	3~4	15~20	6-8	280	130	- 40~130
Devcon® HA1808	Gray	1.00	8~10	. 110	8.5	350	120	-40~130
Devcon® HA1820	Gray	1.00	20~25	120	7.6	300	150	-40~130
						•	ROHS TEAO FREE	REACH @



uctural™ es no paint onding properties ngineering astic materials,	A two-part multi-structural™ adhesive that requires no paint primer. With good bonding properties not only for regular metals, engineering materials, thermoplastic materials, glass, etc., but also for PET, PA, PP and other materials that are hard to be bonded.
perty. e a wide of base materials naterials. y. y. th. e for improved	 Long operation time. These adhesives have a wide application coverage of base materials and can bond most materials. Outstanding flexibility. Good bonding strength. Low rate of shrinkage for improved appearance quality.
lC	ORDERING

Polyurethane Structural Adhesives

Devcon[®]/ Krafft[®]

Product Description

High performance two-part polyurethane structural adhesives that can be used for bonding composite materials, wood, thermoplastic plastics, cement, concrete, etc. Featuring simple operation, fast curing, and high thixotropic property. Once the adhesive is cured, product is provided with high strength and good resistance to aging.

Devcon [®] Dev-Thane™ 2130							E	Krafft [®] NOVATTANE 2100S				
A two-part polyurethane structural adhesive.				A two-part polyurethane structural adhesive.				A two-part polyurethane structural adhesive.				
room temp •Thixotropic •Suitable fo materials, • PET films. •Good weat	perature. c for conve r bonding especially thering res	e and fast curr enient operat a variety of alloy alumin istance. Capa eliability and	ion. um, able of	curring at •Thixotropi •Suitable fo materials, PET films. •Good wea	room temp ic for conve or bonding especially thering res	enient operati a variety of alloy alumine	on. um,	curring at •Thixotropi •Suitable fo materials, PET films. •Good weat	room temp c for conve or bonding especially thering res	enient operati a variety of alloy aluminu	on. um,	
PRODUCT NAME	ORDERING Code	SPECIFICATIONS	PACKAGING	PRODUCT NAME	ORDERING CODE	SPECIFICATIONS	PACKAGING	PRODUCT NAME	ORDERING Code	SPECIFICATIONS	PACKAGING	
Devcon® Dev-Thane™ 2130	30006	400 ml	12	NOVATTANE 2100	21007	400ml	12	NOVATTANE 2100/2100S Part B	36290	150L	1	
Devcon [®] Dev-Thane™ 2130 Part A	30018	150 L	1	NOVATTANE 2100 Adhesive	21009	15L	1	NOVATTANE 2100S Part A	36240	150L	1	
Devcon® Dev-Thane™ 2130 Part A	30008	5 Gal	1	NOVATTANE 2100 Activator	21010	15L	1		-		· · · · · · · · · · · · · · · · · · ·	
Devcon® Dev-Thane™	30019	150 L	1	NOVATTANE 2100S	21007S	400ml	12		- - - - - - -		1 4 4 5 6 6 6 6 6 6 6 6 6 6 7 7 7 8 7 8 7 8 7 8	
2130 Part B	30009	5 Gal	1	NOVATTANE 2100S Adhesive	21009S	15L	1		•		· · · ·	
Dev-Thane™ 2130 Part B			_	NOVATTANE 2100S Activator	210105	15L	1				· · · · · · · · · · · · · · · · · · ·	
				NOVATTANE 2100 Part A	36280	150L	1		- - - - - - - - - - - -		1 2 3 4 4 5 6 6 7 8 8 8 8 8 8 8 8 8 8 8 8 8	
			- - - - - - - - - - - - - - - - - - -	NOVATTANE 2100/2100S Part B	36290	150L	1					

Polyurethane Structural Adhesives

Technical Parameters

Product Name	Color	Mixing Ratio	Viscosity (Cps)	Operation Time (Min)	Clamping Duration (Hrs)	Specific Gravity	Tensile Shearing Strength (Mpa)	Elongation (%)	Temperature Tolerance Range(°c)
Devcon® Dev-Thane™ 2130	Gray	1:1	A:50,000~90,000 B:50,000~90,000	30	3.5	1.51	11.03	5~10	- 40~121
Krafft NOVATTANE 2100	Beige/black	1:1	A:50,000~90,000 B:50,000~90,000	4	2	1.59	9	5~10	- 40~121
Krafft NOVATTANE 2100S	Beige	1:1	A:50,000~90,000 B:50,000~90,000	8.5	2.5	1.59	12	5~10	- 40~121



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Modified Silicane Sealants

Schnee-Morehead[®]

Product	Description	

One-part neutral modified silicane sealants that can be used for sealing and elastic bonding of a variety of materials. Cured in moisture. solvent-free. Once cured, product is provided with UV and chemical resistance and can endure spray coating.

	SM1030				SM2030				
	art moderate m sealant.	odulus modif	fied		part high modulu e sealant.	s modified			
variety ∙Fast cu ∙Outstai	 Suitable for sealing and bonding of a variety of materials. Fast curing at room temperature. Outstanding weathering resistance. Solvent-free, more environment-friendly. 			 High strength. Suitable for sealing and bonding of a variety of materials. Fast curing at room temperature. Solvent-free, more environment-friendly. Outstanding weathering resistance 					
PRODUCT NAME	ORDERING CODE	SPECIFICATIONS P	PACKAGING	PRODUCT NAME	ORDERING CODE	SPECIFICATIONS	PACKAGIN		
PRODUCT NAME SM1030		600 ml	PACKAGING	PRODUCT NAME SM2030		:	PACKAGIN		

Technical Parameters

Product Name	Color	Mixing Ratio	Viscosity (Cps)	Operation Time (Min)	Clamping Duration (Hrs)	Specific Gravity	Tensile Shearing Strength (Mpa)	Elongation (%)	Temperature Tolerance Range(°c)
SM 1030 WHT 🕂 🔃 R	White	Single Component	Paste	25	24	1.45	2.2	600	- 40~90
SM 1030 BLK 🖪 🔃 R	Black	Single Component	Paste	25	24	1.45	2.2	550	- 40~90
SM 2030 WHT 🕂 🔁 R	White	Single Component	Paste	15	24	1.45	2.8	450	- 40~90
SM 2030 BLK 🕑 🔁 R	Black	Single Component	Paste	15	24	1.45	2.8	450	- 40~90
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Electronics Potting Materials

Product Description

Electronics potting materials are mainly used in modern electronics industry. For improving the integrity of electronic components and increasing their resistance to external impact and vibration. Capable of preventing direct exposure of components and circuits and improving electronic components' waterproof and moistureproof capacity. For providing insulation between components and circuits and heat dissipation and protection functions in order to facilitate the downsizing and weight-reducing of products.

Organosilicon Potting Adhesives - Product Description

Flame retardant, weathering resistant silica gel potting materials. Suitable for potting components with heat emission to protect the electronic components. Compatible with most with insulation materials thanks to their excellent stability and electrical performance.

🖒 Outstanding Tolerance With High- And Low-temperature

🖒 Good Flexibility 👘 Better Insulation Property Than E

Epoxy Potting Adhesives - Product Description

Used for protecting electronic components, such as bonding heat sink. Capable of solving heat conductivity problems encountered during SMT and/or film fixation.						
🖒 Good Mechanical Properties	🖒 Requires No Paint Primer	🖒 Working Temperature Up To 155°c				
🖒 Low Exothermic Peak Height ar	nd Less Shrinkage During Curing	g Process 🖞 Anti-piracy				

Silicon Paint Primer Potting Materials - Description

Silicane paint primers are dilute solutions of active silicon resin that can improve the adhesive force of a variety of microelectronics coatings and the majority of silica gels to base materials(substrates). Used in condensate and/or additive liquid silicon rubbers. Clear paint primer suitable for transparent silica gel system. Suitable for use on metals, timber, glass, ceramics and a variety of plastics.

Organosilicon Potting Adhesive Products

INSULCAST®	
RTVS 42 CURTIS II	

INSULCAST®

Containin promotor and plast Contribut virtue of t water abs Outstand hot impac	ng silicane a is for better ics. ing to good their high el sorption. ling resistar ct. ling insulati	ting adhesive dhesion bonding of m l leak-proofne asticity and lo nce to cold- ar on property a	etals ess by ow nd/or	
аррисанс	on salety.			
PRODUCT NAME	ORDERING Code	SPECIFICATIONS	PACKAGING	
INSULCAST [®] RTVS 42	IS130R (Base Agent)	5 Gal	1	
CURTIS II	IS130H (Curing Agent)	1 Gal	1	

RTVS 3-95-2

	adhesive with high th tivity.
etals	· High thermal conduct
	 Outstanding impact re
ss by	weathering resistance
w	equipment service life
	· Low viscosity, good flu
id/or	potting performance.
	·This adhesive has high
nd	provide protection to
nu	components.
	·UL94, V-0 certified.

PRODUCT NAME	ORDERING CODE	SPECIFICATIONS	PACKAGING	PRODUCT NAME	ORDERING CODE	SPECIFICATIONS	PACKAGING
INSULCAST [®]	IS300R	1 Gal	1	INSULCAST [®]	IS 13701- C	27 Kg	1
RTVS	(Base Agent)			RTVS	(Base Agent)	• • •	-
3-95-2	IS300H (Curing Agent)	1 Gal	1	8127 LV-C	IS 13702- C (Curing Agent)	. 0	1

e:-55°c~260°c	🖒 No Stress Shrinkage
Epoxy Resin	🖒 Outstanding Weathering Resistance

RTVS 8127 LV-C

INSULCAST®

A two-part organosilicon potting high thermal conduc-

conductivity. npact resistance and

- sistance for extending rvice life.
- good fluidity, and good

has high strength which ction to electronic

An organosilicon potting adhesive with low viscosity and high thermal conductivity.

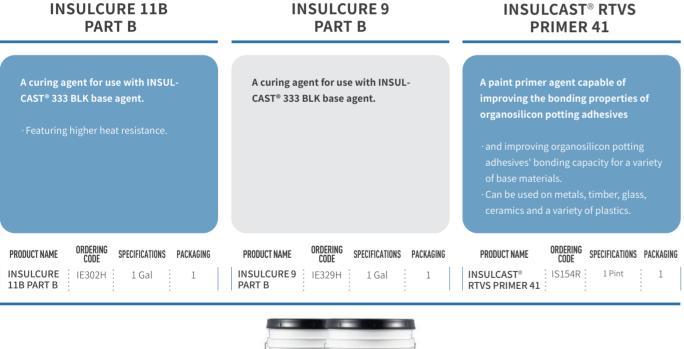
Electronics Potting Materials

INSULCAST[®]

Epoxy Potting Adhesive Products

INSULCAST [®] 116 FR	INSULCAST [®] 117 FR	INSULCAST [®] 333 BLK PART A		
 A two-part epoxy potting adhesive. High thermal conductivity for its good heat dissipation. Low viscosity, meeting a variety of potting requirements. Excellent resistance to high- and low-temperature impact; improved product reliability. Environment-friendly and safe, less odorous. UL94.V0 certified. 	 A two-part epoxy potting adhesive. High thermal conductivity for its good heat dissipation. Short clamping duration for simplified production process. Outstanding bonding capacity up to the requirements for structural bonding of base materials. Excellent resistance to high- and low-temperature impact and resistance to aging, capable of improving product service life. Good waterproof performance. 	A UL94,V-0 certified epoxy potting adhesive with moderate viscosity • Good insulation property. • Excellent thermal conductivity. • Good waterproof performance.		
PRODUCT NAME ORDERING CODE SPECIFICATIONS PACKAGING INSULCAST* IE127R 25 Kg 1 116 FR Base Agent) IE127H 25 Kg 1 IL127H 25 Kg 1 1	PRODUCT NAME ORDERING CODE SPECIFICATIONS PACKAGING INSULCAST® IE129R 25 Kg 1 117 FR (Base Agent) IE129H 25 Kg 1 IE129H 25 Kg 1 IE129H 1	PRODUCT NAME ORDERING CODE SPECIFICATIONS PACKAGING INSULCAST® 333 IE157R 5 Gal 1 BLK PART A Image: Specification of the second sec		

Silicon Paint Primer Potting Adhesives - Product Description





Electronics Potting Materials

Electronics Potting Materials (A/B)	Heat Conductivity	Inflammability	Fill or Not	Low Stress	Low Viscosity	Resistance to High Temperature	Resistance to High Pressure
INSULCAST [®] RTVS 42 CURTIS II			Yes	. √			$\sqrt{-}$
INSULCAST® RTVS 3-95-2			Yes				
INSULCAST® RTVS 8127 LV- C			Yes				$\sqrt{-}$
INSULCAST® 116 FR FC			Yes	· · ·	- - - - -		
INSULCAST [®] 333 BLK PART A INSULCURE 11B PART B			Yes				$\sqrt{-}$
INSULCAST [®] 333 BLK PART A INSULCURE 9 PART B			Yes				
INSULCAST® RTVS PRIMER 41			No	•		• • • • • • • • • • • • • • • • • • •	

Organosilicon Potting Adhesives - Technical Parameters

Product Name	INSULCAST® RTVS 42 CURTIS II	INSULCAST® RTVS 3- 95-2	INSULCAST® RTVS 8127 LV- C		
Color	Black	Red	Black		
Mixing Ratio	100:4.8	1:1	1:1		
Specific Gravity	1.43	2.32	1.78		
Viscosity (Cps)	16,000	35,000	4,000		
Gelation Time @ 25°c	<20 mins	2- 4 hrs	150 mins		
Curing Time	24 hrs@25°C or 1 hrs@80°C	24 hrs@25°C or 1 hrs@80°C	24 hrs@25°C or 1 hrs@80°C		
Hardness (Shore)	75A	85A	55A		
Coefficient of Thermal Expansion (/degree Celsius)	45×10 ⁻⁵	15×10-5	18×10 ⁻⁵		
Vitrification Temperature (Td), °c	- 60	/	- 52		
Thermal Conductivity (W/m·k)	0.58	1.5	0.75		
Temperature Tolerance Range(°c)	- 55 to 125	- 55 to 260	- 55 to 204		
Certification /flame Retardant Rating	UL94,V- 0	UL94,V- 0	UL94,V- 0		

" $\sqrt{}$ " denotes the presence of the described characteristic.

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Electronics Potting Materials

INSULCAST[®]

Epoxy Potting Adhesives - Technical Parameters

Product Name	INSULCAST® 116 FR 🕲 R	INSULCAST® 117FR	INSULCAST® 333 INSULCURE BLK PART A 11B PART B	INSULCAST® 333 INSULCURE BLK PART A 9 PART B 🔞 R		
Color	Black, White White, Gray Black		Black	Black		
Mixing Ratio	1:1	1:1	100:8	100:6		
Density after Mixing (g/cm3)	1.48	1.56	1.50	1.50		
Viscosity (Cps)	8,100	12,000	3,000	2,000		
Operation Time	1.5 hrs	3-4 mins	2.5 hrs	1 hrs		
Gelation Time	3- 4 hrs	1- 2hrs	/	/		
Coefficient of Thermal Expansion (/°C)	30×10 ⁻⁶	35×10 ⁻⁶	48×10 ⁻⁶	48×10 ⁻⁶		
Hardness (Shore)	75D	75 D	85 D	85 D 0.61		
Thermal Conductivity (W/m-k)	0.67	0.67	0.61			
Temperature Tolerance Range(°c)	- 40~105	- 40~105	- 40~105	- 40~155		
Certification /flame Retardant Rating	UL94,V- 0	UL94,V- 0	UL94,V- 0	UL94,V- 0		

Silicon Paint Primer Potting Materials - Technical Parameters

Product Category	Product Name	Color	Density (G/cm³)	(Dry) Curing Time (Hrs)	Viscosity (Cps)	Solid Content (%)	Solvents
Silicon Paint Primer Potting Materials*	INSULCAST [®] RTVS PRIMER 41	Blue	0.83	1	1	10	Naphtha
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* Kept in a shady and cool place. Stored at a well-ventilated place. Kept away from heat sources, sparks and naked flame.